

## LNPTM THERMOCOMPTM COMPOUND DX06094

## DESCRIPTION

LNP THERMOCOMP DX06094 compound is based on Polycarbonate (PC) resin containing 30% glass fiber. Added features of this grade include: High Impact, Non- Brominated & Non-Chlorinated Flame Retardant and Mold Release.

GENERAL INFORMATION	
Features	Flame Retardant, Non Cl/Br flame retardant, Enhanced mold release, High stiffness/Strength, Impact resistant
Fillers	Glass Fiber
Polymer Types	Polycarbonate (PC)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Building and Construction	Water Management
Consumer	Home Appliances
Packaging	Industrial Packaging, Food & Beverage

## TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL <sup>(1)</sup>			
Tensile Stress, break, 5 mm/min	145	MPa	ISO 527
Tensile Strain, break, 5 mm/min	3	%	ISO 527
Tensile Modulus, 1 mm/min	9000	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	208	MPa	ISO 178
Flexural Stress, break, 2 mm/min	206	MPa	ISO 178
Flexural Modulus, 2 mm/min	8500	MPa	ISO 178
IMPACT <sup>(1)</sup>			
Izod Impact, unnotched 80*10*4 +23°C	48	kJ/m²	ISO 180/1U
Izod Impact, notched 80*10*4 +23°C	12	kJ/m²	ISO 180/1A
THERMAL <sup>(1)</sup>			
CTE, 23°C to 60°C, flow	2.3E-05	1/°C	ISO 11359-2
CTE, 23°C to 60°C, xflow	6.9E-05	1/°C	ISO 11359-2
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	138	°C	ISO 75/Af
Relative Temp Index, Elec <sup>(2)</sup>	80	°C	UL 746B
Relative Temp Index, Mech w/impact <sup>(2)</sup>	80	°C	UL 746B
Relative Temp Index, Mech w/o impact <sup>(2)</sup>	80	°C	UL 746B
PHYSICAL <sup>(1)</sup>			
Mold Shrinkage, flow <sup>(3)</sup>	0.12	%	SABIC method
Mold Shrinkage, xflow <sup>(3)</sup>	0.47	%	SABIC method
Density (Molded)	1.42	g/cm³	ISO 1183
FLAME CHARACTERISTICS (2)			

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CHEMISTRY THAT MATTERS



PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
UL Yellow Card Link	<u>E45329-101358129</u>		-
UL Recognized, 94V-0 Flame Class Rating	≥3	mm	UL 94
INJECTION MOLDING (4)			
Drying Temperature	120	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.02	%	
Melt Temperature	305 – 325	°C	
Front - Zone 3 Temperature	320 – 330	°C	
Middle - Zone 2 Temperature	310 – 320	°C	
Rear - Zone 1 Temperature	295 – 305	°C	
Mold Temperature	80 - 110	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

(1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.

(2) UL Ratings shown on the technical datasheet might not cover the full range of thicknesses and colors. For details, please see the UL Yellow Card.

(3) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.

(4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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